

Filed Via Express Mail pursuant to 37 C.F.R. 1.10

ecord No.: EL 980 186 972 US

On: <u>DECEMBER 4, 2003</u>

LINDA E. HASTINGS

Any fee due as a result of this paper, not covered by an enclosed check, may be charged on Deposit Acct. No. 50-1290.

## Attorney Docket No.: NECB 19.265 (100806-00068)

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor:

Michiaki MARUOKA

Serial No.:

10/024,103

Filed:

December 17, 2001

Title:

SEMICONDUCTOR DEVICE HAVING BONDING PAD

ELECTRODE OF MULTI-LAYER STRUCTURE

Examiner:

Khiem D. Nguyen

Group Art Unit:

2823

Commissioner for Patents P. O. Box 1450 Alexandria, VA 22313-1450

## RESPONSE TO OFFICE ACTION

SIR:

In response to the Office Action mailed on September 4, 2003, please consider the following remarks: